STM9930A

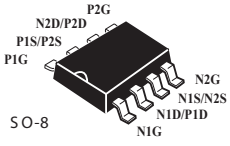
SamHop Microelectronics Corp.

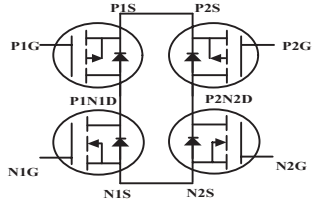
Dec.20, 2005

2N and 2P Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY (N-Channel)		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Max
30V	6A	35 @ V_{GS} = 10V
		54 @ V_{GS} = 4.5V

PRODUCT SUMMARY (P-Channel)		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Max
-30V	-5.3A	53 @ V_{GS} = -10V
		75 @ V_{GS} = -4.5V





ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		V_{DS}	30	-30	V
Gate-Source Voltage		V_{GS}	±20	±20	V
Drain Current-Continuous [a] @ Ta	25°C	I_D	6	-5.3	A
	70°C		4	-3.5	A
-Pulsed [b]		I_{DM}	20	-20	A
Drain-Source Diode Forward Current [a]		I_S	1.7	-1.7	A
Maximum Power Dissipation [a]	Ta= 25°C	P_D	2		W
	Ta=70°C		1.44		
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient [a]	$R_{\theta JA}$	62.5	°C/W

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N-Channel ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ [c]	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250uA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=24V, V_{GS}=0V			1	uA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}= 0V			±100	nA
ON CHARACTERISTICS [b]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D = 250uA	1	1.5	3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=5A		29	35	m ohm
		V_{GS}=4.5V, I_D= 3A		42	54	m ohm
On-State Drain Current	$I_{D(ON)}$	V_{DS} = 5V, V_{GS} = 4.5V	20			A
Forward Transconductance	g_{FS}	V_{DS} = 10V, I_D= 5A		8		S
DYNAMIC CHARACTERISTICS [c]						
Input Capacitance	C_{ISS}	V_{DS} =25V, V_{GS} = 0V f =1.0MHz		550		pF
Output Capacitance	C_{OSS}			130		pF
Reverse Transfer Capacitance	C_{RSS}			60		pF
Gate resistance	Rg	V_{GS} =0V, V_{DS} = 0V, f=1.0MHz		2.3		ohm
SWITCHING CHARACTERISTICS [c]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD} = 15V I_D = 1 A V_{GS} = 10V R_{GEN} = 6 ohm		7		ns
Rise Time	t_r			8		ns
Turn-Off Delay Time	$t_{D(OFF)}$			15		ns
Fall Time	t_f			6		ns
Total Gate Charge	Q_g	V_{DS} =15V, I_D =5A, V_{GS} =10V		13		nC
		V_{DS} =15V, I_D =5A, V_{GS} =4.5V		6.6		nC
Gate-Source Charge	Q_{gs}	V_{DS} =15V, I_D = 5 A V_{GS} =10V		1.4		nC
Gate-Drain Charge	Q_{gd}			3.8		nC

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P-Channel ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ [c]	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=-250uA	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-24V, V_{GS}=0V			-1	uA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}= 0V			±100	nA
ON CHARACTERISTICS [b]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250uA	-1	-1.5	-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D= -5A		44	53	m ohm
		V_{GS}=-4.5V, I_D= -3A		62	75	m ohm
On-State Drain Current	$I_{D(ON)}$	V_{DS}= -5V, V_{GS}= -10V	-20			A
Forward Transconductance	g_{FS}	V_{DS}= -10V, I_D=-5A		9		S
DYNAMIC CHARACTERISTICS [c]						
Input Capacitance	C_{ISS}	V_{DS}=-25V, V_{GS}= 0V f=1.0MHz		650		pF
Output Capacitance	C_{OSS}			170		pF
Reverse Transfer Capacitance	C_{RSS}			100		pF
Gate resistance	Rg	V_{GS}=0V, V_{DS}= 0V, f=1.0MHz		2.2		ohm
SWITCHING CHARACTERISTICS [c]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD}= -15V I_D= -1A V_{GS}= -10V R_{GEN}= 6 ohm		9		ns
Rise Time	t_r			16		ns
Turn-Off Delay Time	$t_{D(OFF)}$			51		ns
Fall Time	t_f			36		ns
Total Gate Charge	Q_g	V_{DS}=-15V, I_D=-5A,V_{GS}=-10V		13		nC
		V_{DS}=-15V, I_D=-5A,V_{GS}=-4.5V		6.6		nC
Gate-Source Charge	Q_{gs}	V_{DS}=-15V, I_D= -5 A V_{GS}=-10V		1.2		nC
Gate-Drain Charge	Q_{gd}			4.3		nC

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ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Typ [c]	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [b]							
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is =1.7A	N-Ch		0.82	1.2	V
		V_{GS} = 0V, Is =-1.7A	P-Ch		-0.8	-1.2	

Notes

a.Surface Mounted on FR4 Board, t≤10sec.

b.Pulse Test:Pulse Width≤300 μs, Duty Cycle≤2%.

c.Guaranteed by design, not subject to production testing.

N-Channel

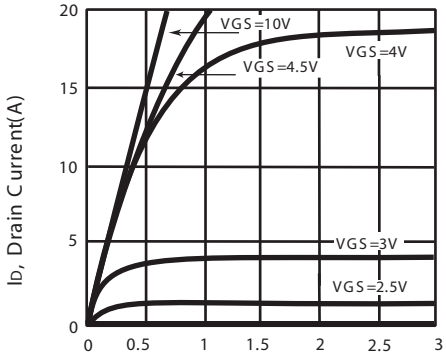

Figure 1. Output Characteristics

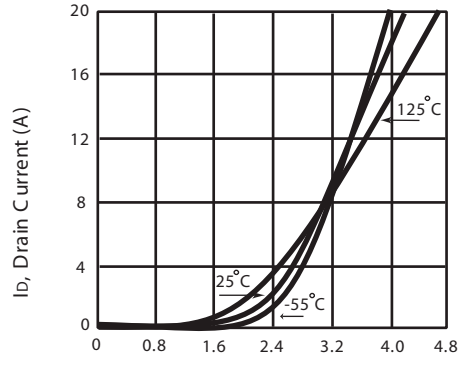

Figure 2. Transfer Characteristics

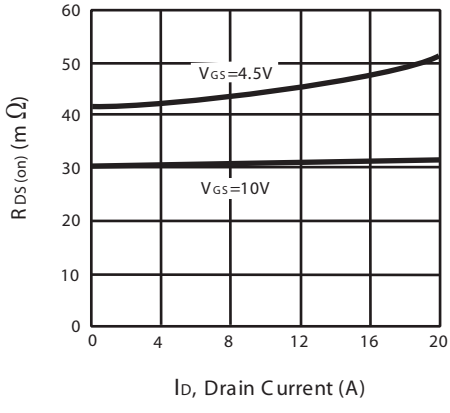

Figure 3. On-Resistance vs. Drain Current and Gate Voltage

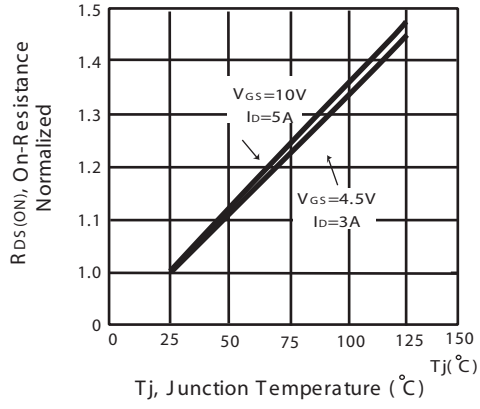

Figure 4. On-Resistance Variation with Drain Current and Temperature

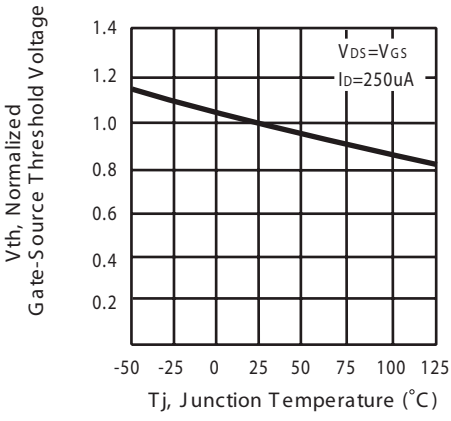

Figure 5. Gate Threshold Variation with Temperature

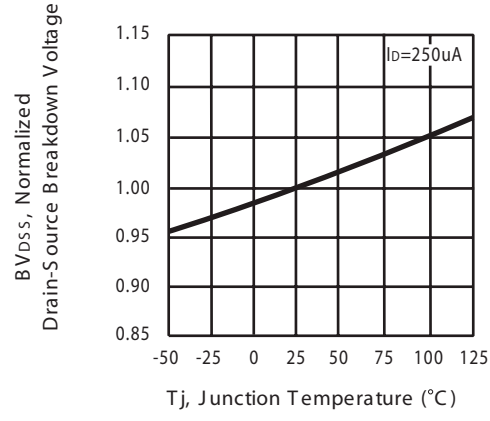

Figure 6. Breakdown Voltage Variation with Temperature

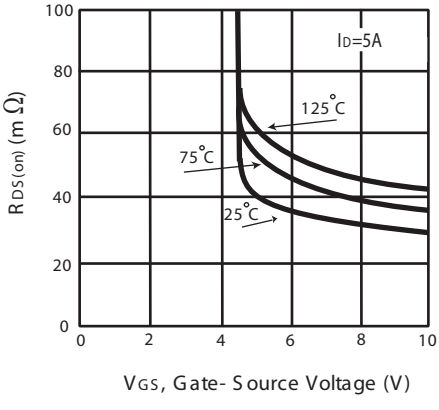

Figure 7. On-Resistance vs. Gate-Source Voltage

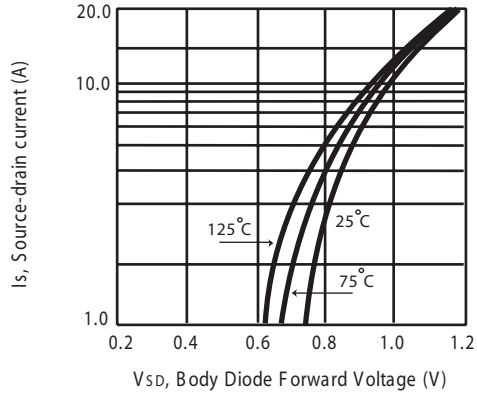

Figure 8. Body Diode Forward Voltage Variation with Source Current

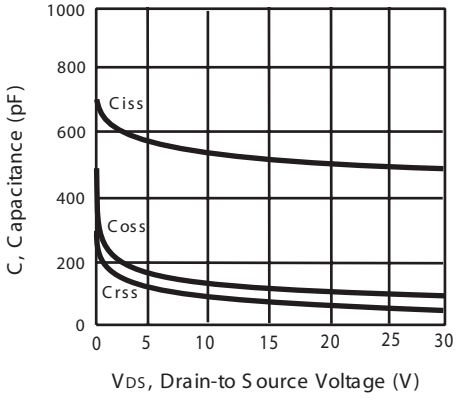

Figure 9. Capacitance

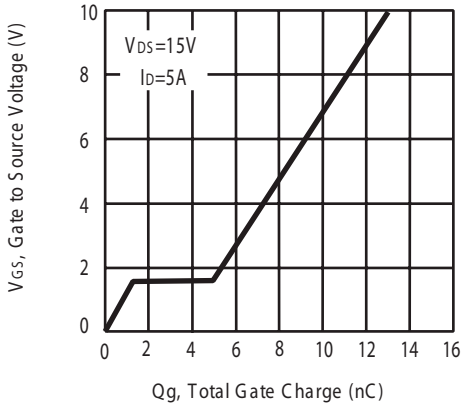

Figure 10. Gate Charge

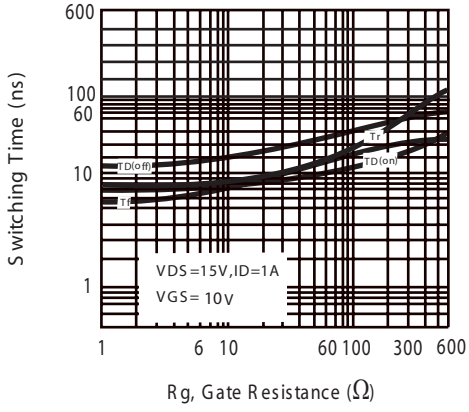

Figure 11.switching characteristics

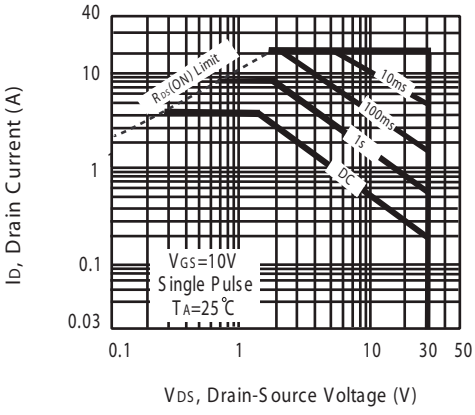

Figure 12. Maximum Safe Operating Area

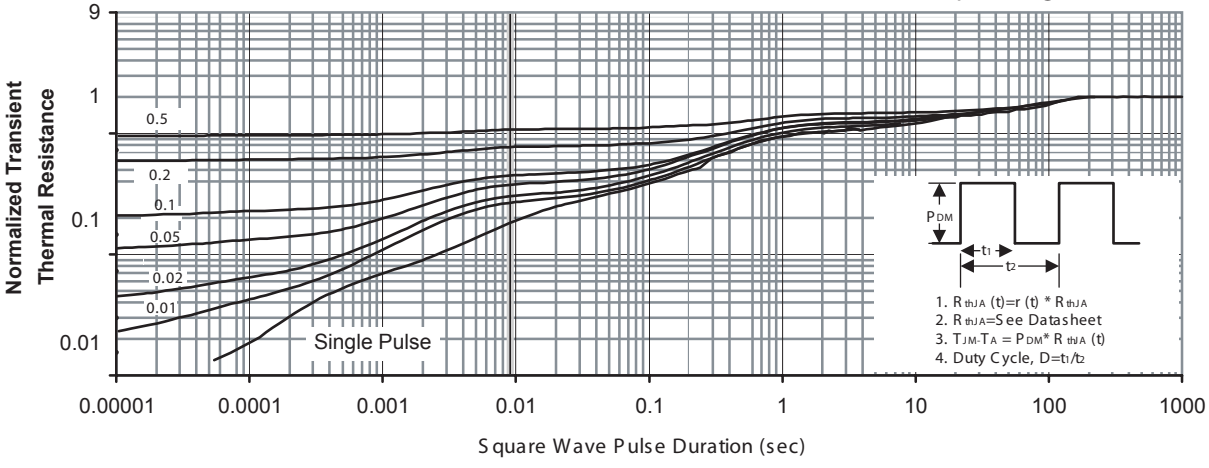

Figure 13. Normalized Thermal Transient Impedance Curve

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P-Channel

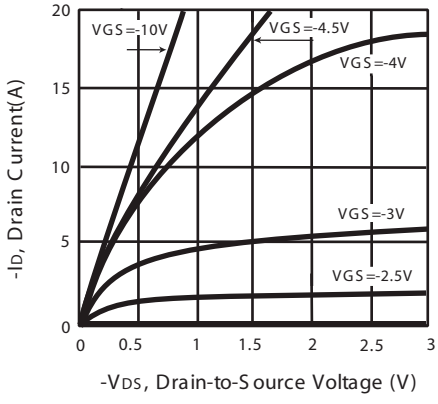
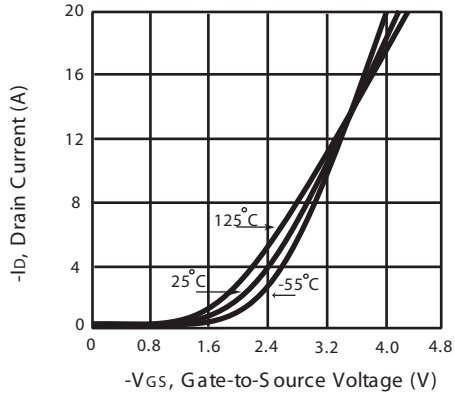


Figure 1. Output Characteristics



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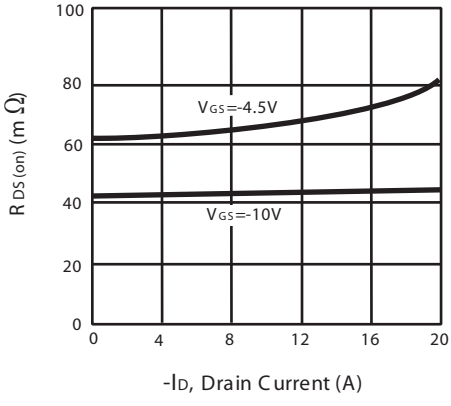

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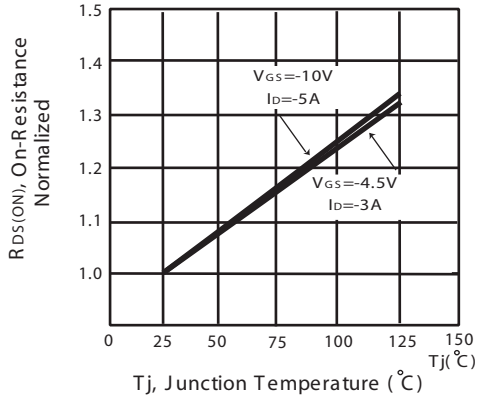


Figure 4. On-Resistance Variation with Drain Current and Temperature

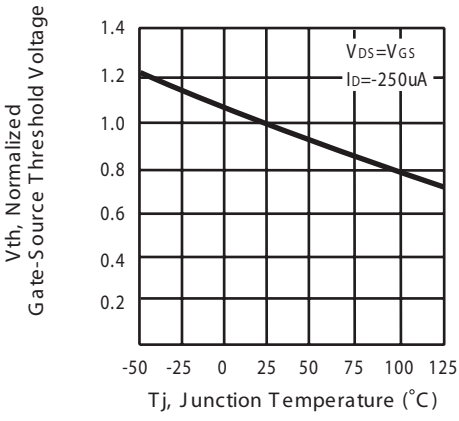


Figure 5. Gate Threshold Variation with Temperature

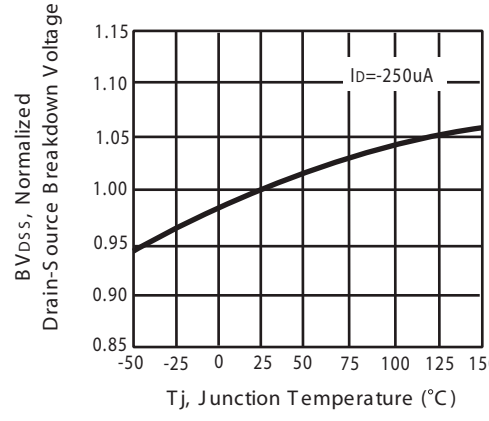


Figure 6. Breakdown Voltage Variation with Temperature

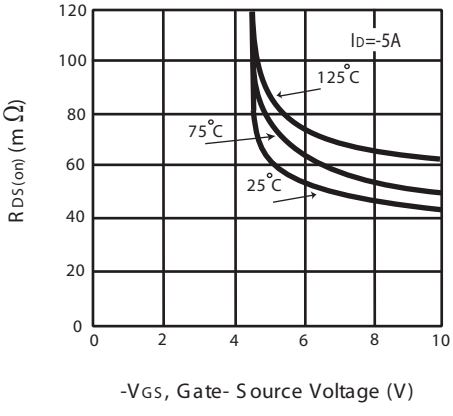
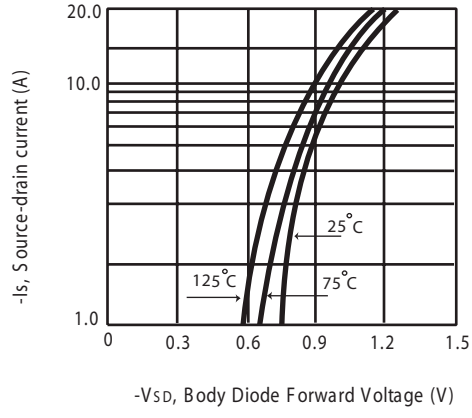


Figure 7. On-Resistance vs. Gate-Source Voltage



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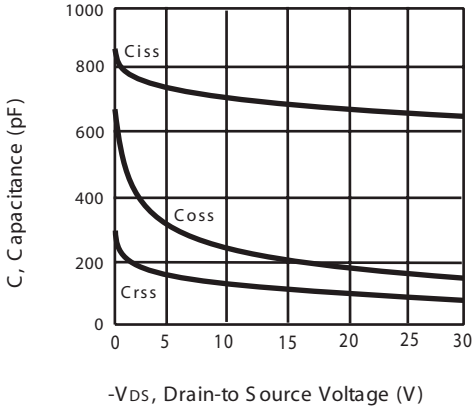

Figure 9. Capacitance

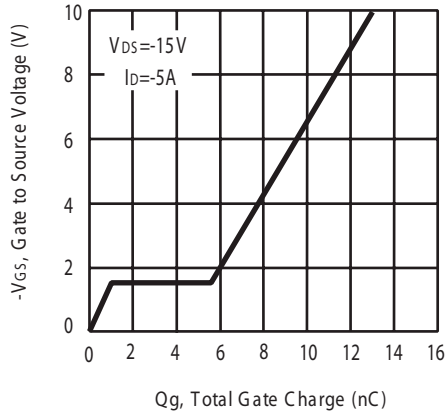

Figure 10. Gate Charge

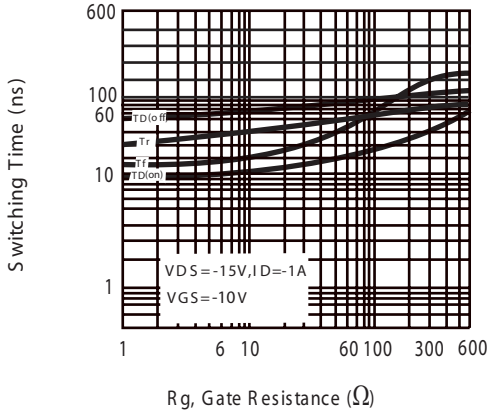

Figure 11.switching characteristics

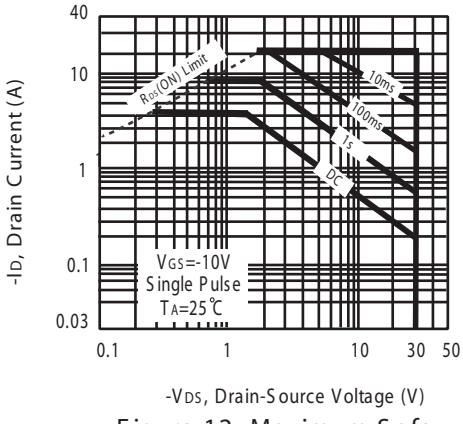

Figure 12. Maximum Safe Operating Area

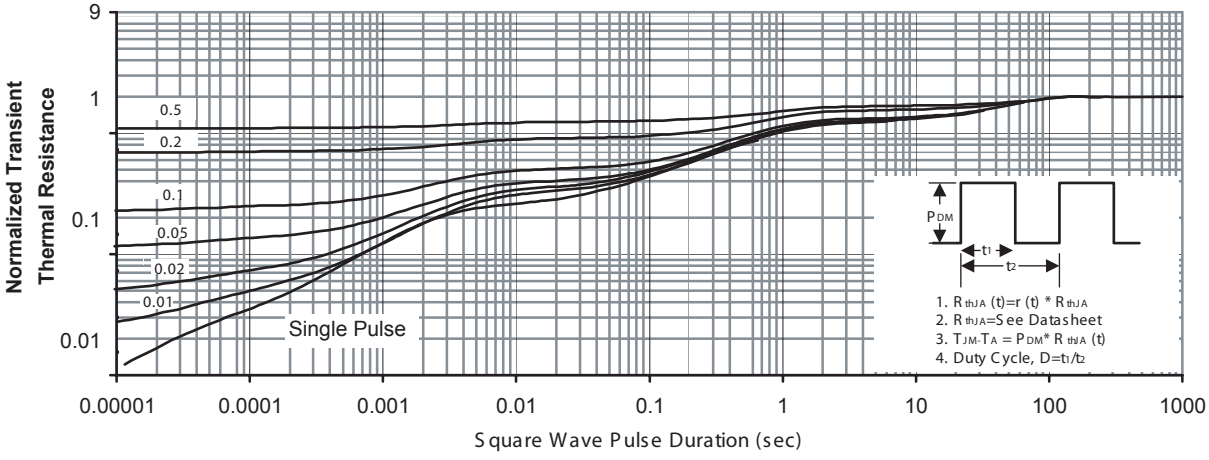

Figure 13. Normalized Thermal Transient Impedance Curve

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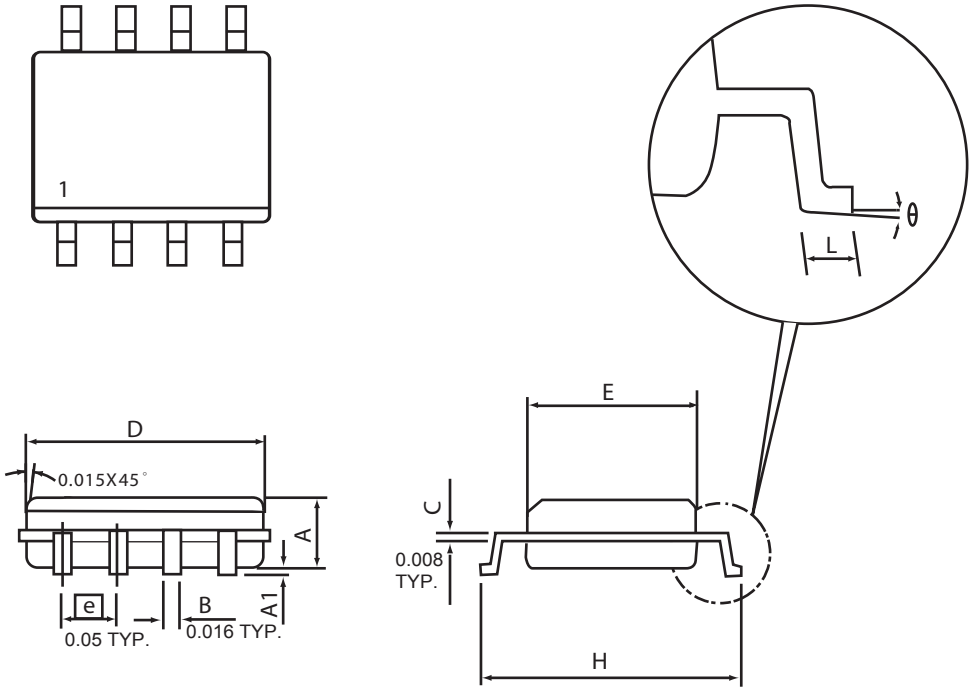
PACKAGE OUTLINE DIMENSIONS

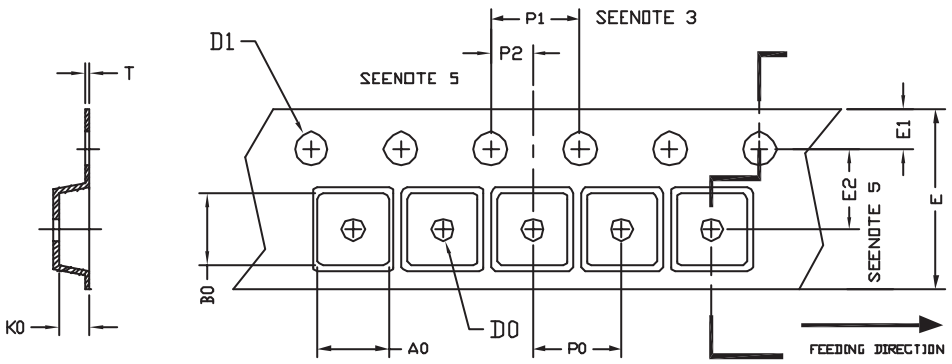
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

SO-8 Tape and Reel Data

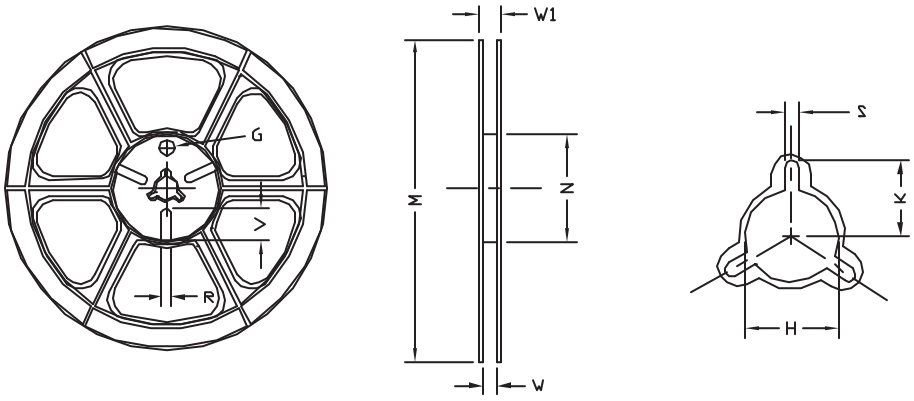
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.40	5.20	2.10	ϕ1.5 (MIN)	ϕ1.5 + 0.1 - 0.0	12.0 ±0.3	1.75	5.5 ±0.05	8.0	4.0	2.0 ±0.05	0.3 ±0.05

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	ϕ330	330 ± 1	62 ±1.5	12.4 + 0.2	16.8 - 0.4	ϕ12.75 + 0.15	---	2.0 ±0.15	---	---	---